

650V N-Channel Power MOSFET

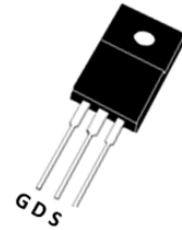
DESCRIPTION :

- Fast Switching
- Improved dv/dt Capability
- 100% UIS Tested, 100%ΔVds Tested
- Fast Recovery Body Diode
- RoHS compliant
- Pb-Free Lead Plating

V_{DS}	650V
$I_D (T_c=25^\circ\text{C})$	10A
$R_{DS(ON_MAX)} @ V_{GS}=10V$	0.95Ω

TYPICAL APPLICATIONS :

- Power Management
- Load Switch
- PWM Application



ITO-220AB

MAXIMUM RATINGS (at $T_A = 25^\circ\text{C}$, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	650	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain Current	$T_c=25^\circ\text{C}$ $T_c=100^\circ\text{C}$	I_D	10 6	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	40	A
Single Pulsed Avalanche Energy ⁽²⁾		E_{AS}	405	mJ
Power dissipation	$T_c=25^\circ\text{C}$	P_D	29	W
Junction & Storage temperature Range		T_J, T_{STG}	-55~+150	°C

Notes : 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. EAS condition: Starting $T_J=25^\circ\text{C}$, $V_{DD}=50V$, $V_G=10V$, $R_G=25\text{ohm}$, $L=10\text{mH}$, $I_{AS}=9A$

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction to Ambient Junction to Case	$R_{\theta JA}$ $R_{\theta JC}$	55 4.3	°C/W

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage $V_{GS} = 0V, I_D = 250\mu A$	$V_{(BR)DSS}$	650			V
Zero Gate Voltage Drain Current $V_{DS} = 650V, V_{GS} = 0V$	I_{DSS}			1	μA
Gate-Source Leakage Current $V_{GS} = \pm 30V, V_{DS} = 0V$	I_{GSS}			± 100	nA
Gate-Source threshold voltage $V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(th)}$	2.0	3.0	4.0	V
Drain-Source On-State Resistance $V_{GS} = 10V, I_D = 5A$	$R_{DS(on)}$		0.84	0.95	Ω
Input capacitance $f=1MHz, V_{DS}=25V, V_{GS}=0V$	C_{iss}		1560		pF
Output capacitance $f=1MHz, V_{DS}=25V, V_{GS}=0V$	C_{oss}		136		pF
Reverse transfer capacitance $f=1MHz, V_{DS}=25V, V_{GS}=0V$	C_{rss}		19		pF
Total Gate Charge $V_{DS}= 520V, I_D= 10A, V_{GS}=0$ to 10V	Q_G		37		nC
Gate to Source Charge $V_{DS}= 520V, I_D= 10A, V_{GS}=0$ to 10V	Q_{GS}		8		nC
Gate to Drain Charge $V_{DS}= 520V, I_D= 10A, V_{GS}=0$ to 10V	Q_{GD}		15		nC
Turn-on delay time $V_{DD}= 310V, V_{GS}= 10V, I_D= 10A, R_{GEN}=24\Omega$	$t_{d(ON)}$		23		ns
Rise time $V_{DD}= 310V, V_{GS}= 10V, I_D= 10A, R_{GEN}=24\Omega$	t_r		37		ns
Turn-off delay time $V_{DD}= 310V, V_{GS}= 10V, I_D= 10A, R_{GEN}=24\Omega$	$t_{d(OFF)}$		104		ns
Fall time $V_{DD}= 310V, V_{GS}= 10V, I_D= 10A, R_{GEN}=24\Omega$	t_f		45		ns

Body Diode

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage $V_{GS} = 0V, I_S = 10A$	V_{SD}			1.2	V
Maximum Continuous Drain to Source Diode Forward Current	I_S			10	A
Maximum Pulsed Drain to Source Diode Forward Current	I_{SM}			40	A
Revers Recovery Time $I_F = 10A, di/dt = 100A/\mu s$	T_{rr}		423		ns
Revers Recovery Charge $I_F = 10A, di/dt = 100A/\mu s$	Q_{rr}		4.4		μC

Typical Performance Characteristics

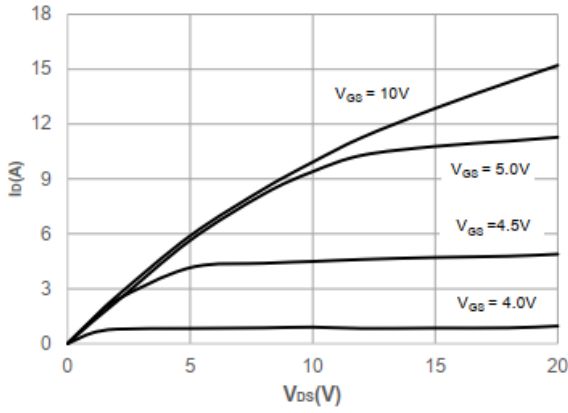


Figure 1. Output Characteristics

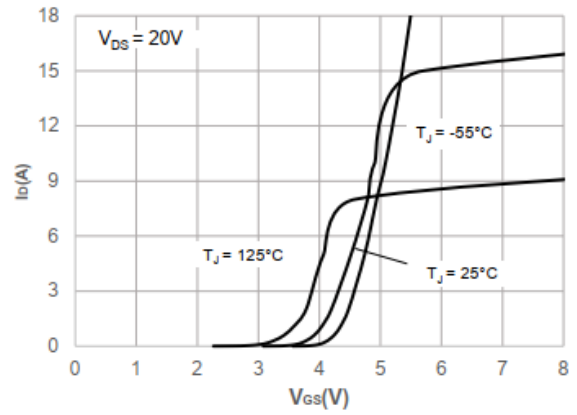


Figure 2. Typical Transfer Characteristics

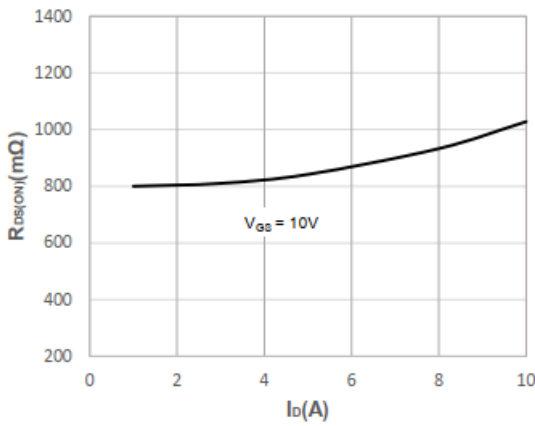


Figure 3. On-resistance vs. Drain Current

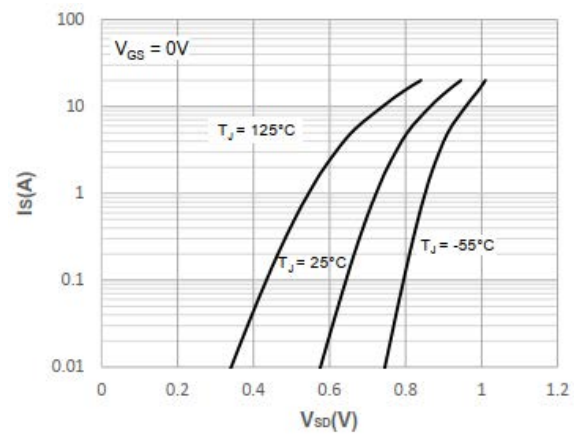


Figure 4. Body Diode Characteristics

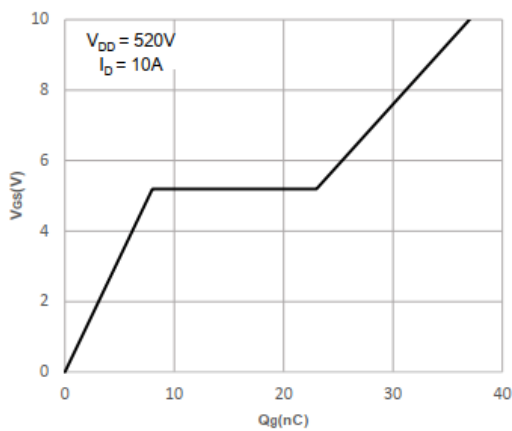


Figure 5. Gate Charge Characteristics

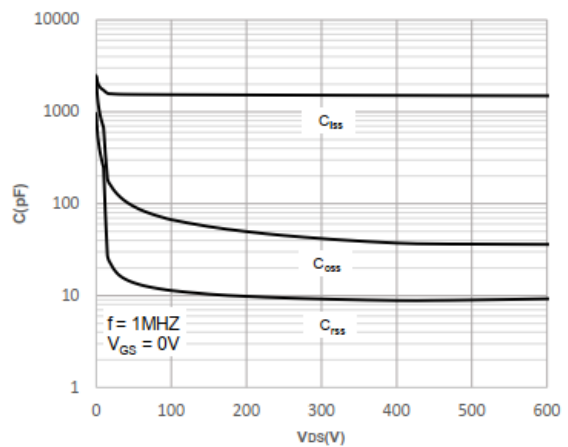


Figure 6. Capacitance Characteristics

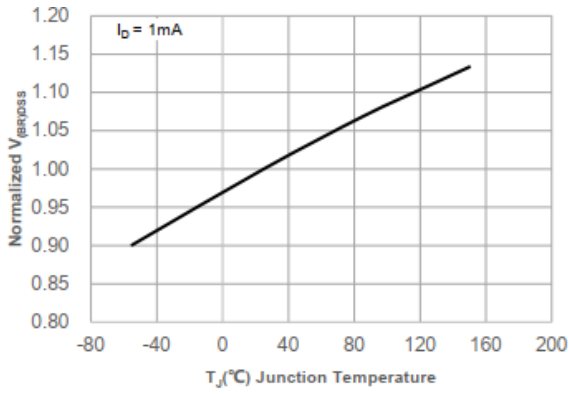


Figure 7. Normalized Breakdown voltage vs. Junction Temperature

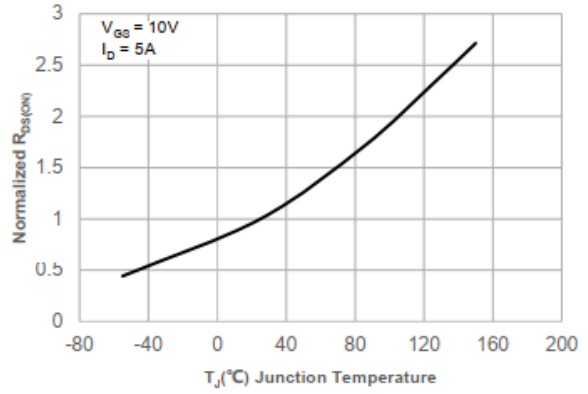


Figure 8. Normalized on Resistance vs. Junction Temperature

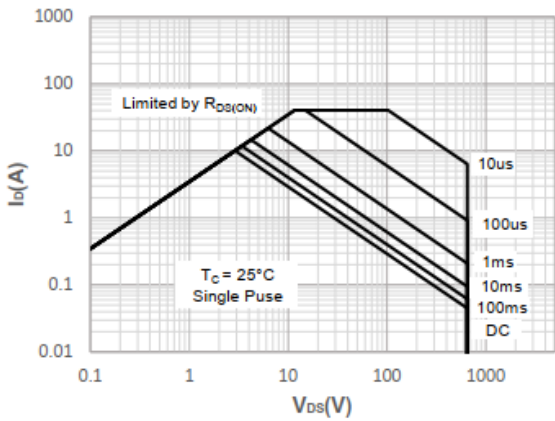


Figure 9. Maximum Safe Operating Area

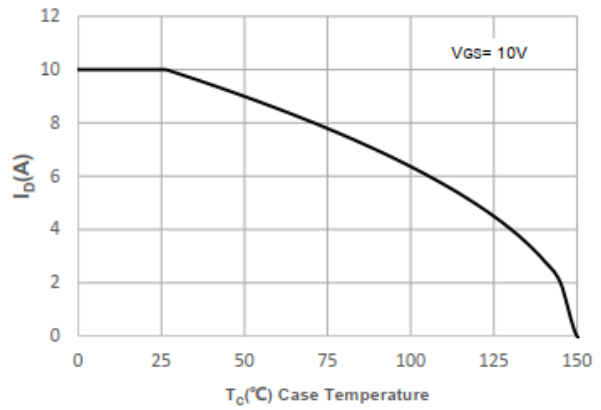


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

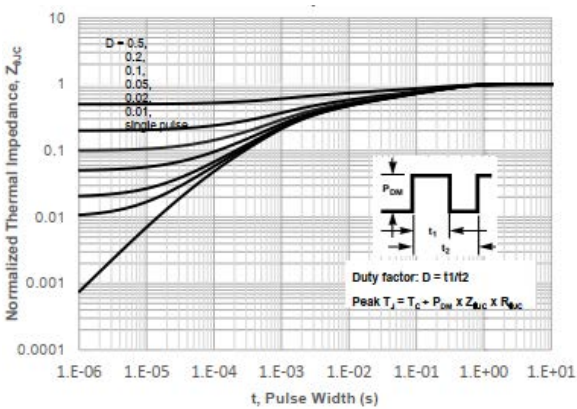


Figure 11. Normalized Maximum Transient Thermal Impedance

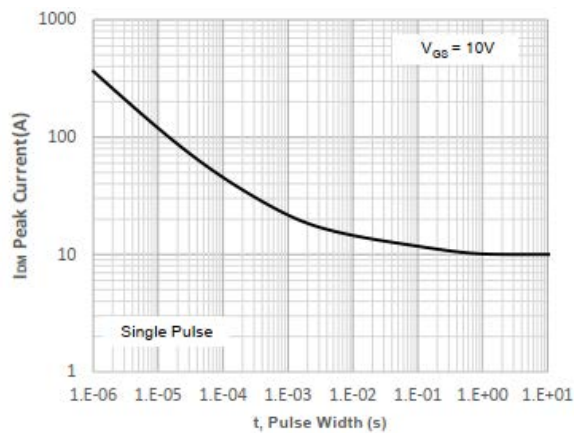
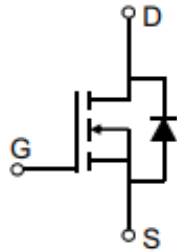
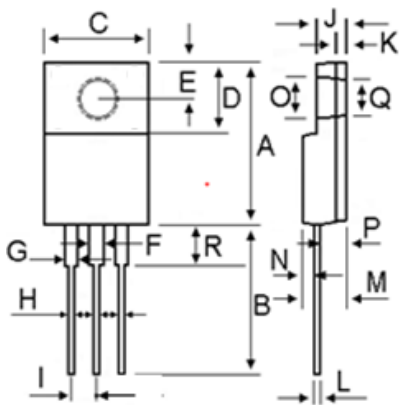


Figure 12. Peak Current Capacity

- Circuit diagram



- Package outlines :



DIM	MILLIMETERS	
	MIN	MAX
A	14.80	16.10
B	12.65	14.40
C	9.70	10.36
D	4.60	6.80
E	2.50	3.50
F	0.90	1.55
G	0.90	1.55
H	0.50	0.90
I	2.40	2.70
J	2.34	3.30
K	0.55	1.30
L	0.36	0.80
M	4.20	4.90
N	1.10	1.80
O	2.90	3.50
P	2.30	3.15
Q	2.90	3.50
R	2.80	4.85

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